



P.C.B layout

NOTES:
 MATERIAL
 HOUSING:HIGH TEMPERATURE THERMOPLASTIC
 CONTACT:COOPER ALLOY
 SHELL:COOPER ALLOY
 PLATING
 CONTACT AREA:GOLD PLATED OVER NI
 SOLDER TAIL:100u" MIN Sn/Pb PLATED OVER NI
 SHELL SOLDER AREA:GOLD PLATED OVER NI
 PATING
 CURRENT RATING:0.5A
 VOLTAGE RATING:250VRMS
 OPERATING
 TEMPERATURE:-25C~+90C
 SPECIFICATION
 CONTACT RESISTANCE:40 MILLIOHMS
 DIELECTRIC WITHSTANDING VOLTAGE:500VAC MEGOHMS
 INSULATION RESISTANCE:100 MEGOHMS
 ORDERING INFORMATION
 MDDMF-111 XX B000
 05-tin/gold 5u"



DIMENSION IN mm [inch]		PROD SPEC	شركة يكتا للإلكترونيك	
TOLERANCE UNLESS OTHERWISE SPECIFIED		PRG. SPEC.	TITLE MINI SD 2.05	
.X±0.30	X'± 1'	APPROVE	CUSTOMER DRAWING	
XX±0.20	X'± 0.5'	CHECK	FILE NO.	DWG NO. MDDMF-111XXB000
.XXX±0.10	XX'± 0.25'	DRAW	SIZE A4	PROJ. SHEET 1 / 1
			SCALE 3:1	REV A